- Contains Eight Flip-Flops With Single-Rail Outputs
- Buffered Clock and Direct Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications Include:

Buffer/Storage Registers Shift Registers Pattern Generators

description

These monolithic, positive-edge-triggered flipflops utilize TTL circuitry to implement D-type flip-flop logic with a direct clear input.

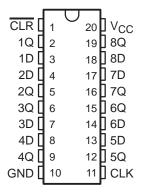
Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect ar the output.

These flip-flops are guaranteed to respond to clock frequencies ranging form 0 to 30 megahertz while maximum clock frequency is typically 40 megahertz. Typical power dissipation is 39 milliwatts per flip-flop for the '273 and 10 milliwatts for the 'LS273.

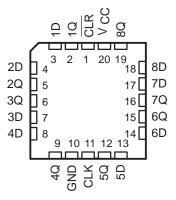
FUNCTION TABLE (each flip-flop)

| ı | NPUTS | | OUTPUT |
|-------|------------|---|----------------|
| CLEAR | CLOCK | D | Q |
| L | Х | Х | L |
| н | \uparrow | Н | Н |
| н | \uparrow | L | L |
| Н | L | Χ | Q ₀ |

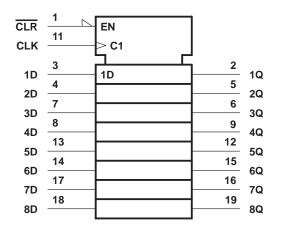
SN54273, SN74LS273 . . . J OR W PACKAGE SN74273 . . . N PACKAGE SN74LS273 . . . DW OR N PACKAGE (TOP VIEW)



SN54LS273 . . . FK PACKAGE (TOP VIEW)



logic symbol†

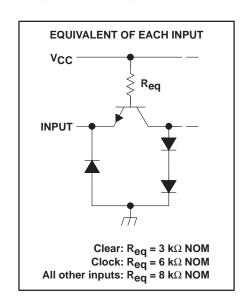


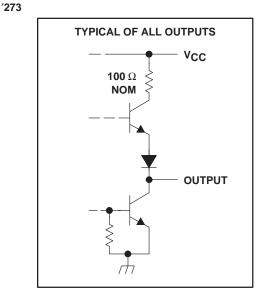
[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the DW, J, N, and W packages.



schematics of inputs and outputs



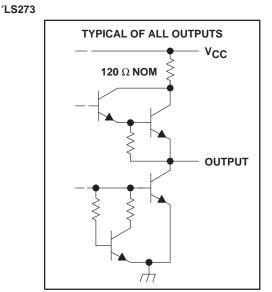


EQUIVALENT OF EACH INPUT

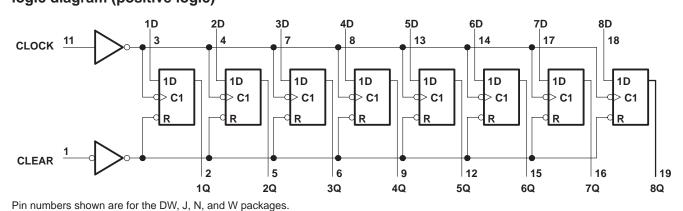
VCC

20 kΩ
NOM

INPUT



logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V _{CC} (see Note 1) | 7 V |
|--|----------------|
| Input voltage | 5.5 V |
| Operating free-air temperature range, T _A : SN54273 | -55°C to 125°C |
| SN74273 | 0°C to 70°C |
| Storage temperature range | -65°C to 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

| | | | SN54273 | | SN74273 | | | UNIT |
|---|----------------------|------|---------|------|---------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Supply voltage, V _{CC} | | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| High-level output current, IOH | | | | -800 | | | μΑ | |
| Low-level output current, IOL | | | 16 | | | 16 | mA | |
| Clock frequency, f _{clock} | 0 | | 30 | 0 | | 30 | MHz | |
| Width of clock or clear pulse, t _W | | 16.5 | | | 16.5 | | | ns |
| Sotup time + | Data input | 20↑ | | | 20↑ | | | 20 |
| Setup time, t _{SU} | Clear inactive state | 25↑ | | | 25↑ | | | ns |
| Data hold time, th | | 5↑ | | | 5↑ | | | ns |
| Operating free-air temperature, TA | | -55 | | 125 | 0 | | 70 | °C |

[↑]The arrow indicates that the rising edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | PARAMETER | | TEST C | ONDITIONS [†] | MIN | TYP‡ | MAX | UNIT | |
|-----------------|---------------------------------------|--|--|---|-----|------|------|------|--|
| VIH | High-level input voltage | | | 2 | | | V | | |
| V _{IL} | Low-level input voltage | | | | | | 0.8 | V | |
| ٧ıK | Input clamp voltage | V _{CC} = MIN, | $I_{I} = -12 \text{ mA}$ | | | -1.5 | V | | |
| Vон | High-level output voltage | V _{CC} = MIN, V _{IL} = 0.8 V, | $V_{IH} = 2 V$, $I_{OH} = -800 \mu A$ | 2.4 | 3.4 | | V | | |
| V _{OL} | Low-level output voltage | | V _{CC} = MIN, V _{IL} = 0.8 V, | V _{IH} = 2 V, I _{OH} = 16 mA | | | 0.4 | V | |
| Ιį | Input current at maximum input voltag | је | V _{CC} = MAX, | V _I = 5.5 V | | | 1 | mA | |
| l | High-level input current | Clear | VMAY | V _I = 2.4 V | | | 80 | | |
| liH | nigh-level input current | Clock or D | V _{CC} = MAX, | V = 2.4 V | | | 40 | μΑ | |
| 1 | Low-level input current | Clear | VCC = MAX, | V _I = 0.4 V | | | -3.2 | mA | |
| ΊL | Low-level input current | Clock or D | VCC = IVIAX, | V = 0.4 V | | | -1.6 | | |
| los | Short-circuit output current§ | | V _{CC} = MAX | | -18 | | -57 | mA | |
| Icc | Supply current | | V _{CC} = MAX, | See Note 2 | | 62 | 94 | mA | |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.



 $^{^\}ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] Not more than one output should be shorted at a time.

SN54273, SN54LS273, SN74273, SN74LS273 OCTAL D-TYPE FLIP-FLOP WITH CLEAR

SDLS090 - OCTOBER 1976 - REVISED MARCH 1988

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------|---|---|-----|-----|-----|------|
| fmax | Maximum clock frequency | | 30 | 40 | | MHz |
| tPHL | Propagation delay time, high-to-low-level output from clear | C _L = 15 pF, | | 18 | 27 | ns |
| tPLH | Propagation delay time, low-to-high-level output from clock | R _L = 400 Ω , See Note 3 | | 17 | 27 | ns |
| tPHL | Propagation delay time, high-to-low-level output from clock | | | 18 | 27 | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V _{CC} (see Note 1) | 7 V |
|--|------------------|
| Input voltage | 7 V |
| Operating free-air temperature range, T _A : SN54LS273 | . −55°C to 125°C |
| SN74LS273 | 0°C to 70°C |
| Storage temperature range | . −65°C to 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

| | | SI | N54LS27 | 3 | SI | 174LS27 | 3 | UNIT |
|---|----------------------|-----|---------|------|------|---------|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | ONII |
| Supply voltage, V _{CC} | | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| High-level output current, IOH | | | | -400 | | | -400 | μΑ |
| Low-level output current, IOL | | | 4 | | | 8 | mA | |
| Clock frequency, f _{clock} | 0 | | 30 | 0 | | 30 | MHz | |
| Width of clock or clear pulse, t _W | | 20 | | | 20 | | | ns |
| Setup time t | Data input | 20↑ | | | 20↑ | | | 20 |
| Setup time, t _{SU} | Clear inactive state | 25↑ | | | 25↑ | | | ns |
| Data hold time, th | • | 5↑ | | | 5↑ | | | ns |
| Operating free-air temperature, TA | - | -55 | | 125 | 0 | | 70 | °C |

The arrow indicates that the rising edge of the clock pulse is used for reference.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | PARAMETER | TEC | T CONDITION | uet | SI | N54LS27 | '3 | SI | N74LS27 | '3 | UNIT |
|-----------------|--|--|------------------------------------|-------------------------|-----|---------|------|-----|---------|------|------|
| | PARAMETER | 153 | I CONDITIO | 151 | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | UNII |
| VIH | High-level input voltage | | | | 2 | | | 2 | | | V |
| VIL | Low-level input voltage | | | | | | 0.7 | | | 0.8 | V |
| ٧ıK | Input clamp voltage | V _{CC} = MIN, | I _I = -18 mA | | | | -1.5 | | | -1.5 | V |
| Vон | High-level output voltage | V _{CC} = MIN, V _{IL} = V _{IL} max, | $V_{IH} = 2 V,$ $I_{OH} = -400$ | μΑ | 2.5 | 3.4 | | 2.7 | 3.4 | | V |
| \/o: | Low-level output voltage | V _{CC} = MIN, | V _{IH} = 2 V, | $I_{OL} = 4 \text{ mA}$ | | 0.25 | 0.4 | | 0.25 | 0.4 | V |
| VOL | Low-level output voltage | V _I L = V _I Lmax, | | $I_{OL} = 8 \text{ mA}$ | | | | | 0.35 | 0.5 | V |
| lį | Input current at maximum input voltage | V _{CC} = MAX, | V _I = 7 V | | | | 0.1 | | | 0.1 | mA |
| lн | High-level input current | $V_{CC} = MAX$, | V _I = 2.7 V | | | | 20 | | | 20 | μΑ |
| I _{IL} | Low-level input current | $V_{CC} = MAX$, | V _I = 0.4 V | | | | -0.4 | | | -0.4 | mA |
| los | Short-circuit output current§ | V _{CC} = MAX | | | -20 | | -100 | -20 | | -100 | mA |
| ICC | Supply current | $V_{CC} = MAX$, | See Note 2 | | | 17 | 27 | | 17 | 27 | mA |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|---|---|-----|-----|-----|------|
| f _{max} | Maximum clock frequency | _ | 30 | 40 | | MHz |
| tPHL | Propagation delay time, high-to-low-level output from clear | $C_L = 15 \text{ pF},$ $R_1 = 2 \text{ k}\Omega,$ | | 18 | 27 | ns |
| tPLH | Propagation delay time, low-to-high-level output from clock | See Note 3 | | 17 | 27 | ns |
| tPHL | Propagation delay time, high-to-low-level output from clock | | | 18 | 27 | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

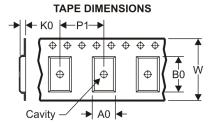
[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time and duration of short circuit should not exceed one second.



TAPE AND REEL INFORMATION





| Α | 0 | Dimension designed to accommodate the component width |
|----|---|---|
| В | 0 | Dimension designed to accommodate the component length |
| | | Dimension designed to accommodate the component thickness |
| ٧ | ٧ | Overall width of the carrier tape |
| ГР | 1 | Pitch between successive cavity centers |

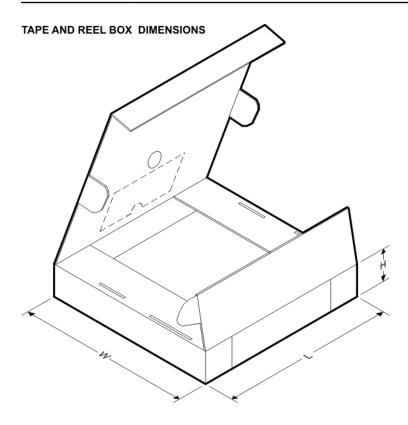
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | _ | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74LS273DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.0 | 2.7 | 12.0 | 24.0 | Q1 |





*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS273DWR | SOIC | DW | 20 | 2000 | 346.0 | 346.0 | 41.0 |

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